

Product / Process Change Notice

Date: October 27, 2023 No.: Z200-PCN-DM202310-01-A Change Title: 4Gb (256Mb x16 and 512Mb x8) DDR3/ DDR3L technology migration from 25nm to 20nm. Change Classification: ☑ Major ☐ Minor with customer notification ☐ Minor without customer notification Change item: □ DataSheet ☑ Design □ Raw Material □ Wafer FAB □ Assembly □ Testing □ Packing □ Manufacture site □ Others Affected Product(s): Please refer to Table 1 in details. Description of Change(s) Technology migration (25nm to 20nm) for 4Gb DDR3/DDR3L. Reason for Change(s): According to Winbond product roadmap, launch new 4Gb DDR3/DDR3L with 20nm technology. Impact of Change(s): (positive & negative) Form: No Change Fit: Change (VFBGA96 PKG size shrink from 9x13MM to 7.5x13MM and VFBGA78 shrink from 9x10.5MM to 8x10.5MM, Please refer to attachment I) Function: No Concern (Compatible between 25nm and 20nm, Please refer to attachment II) (Please refer to attachment III) Reliability: No Concern Hazardous Substances: No Concern (Please refer to attachment IV) Qualification Plan/ Results : Based on Winbond reliability report, the new product meets our criteria and no quality concern (refer to attachment III in details) Implementation Plan: The follow-up disposition of 25nm 256Mb x16 & 512Mb x8 DDR3: 1) The date of last-buy orders for 25nm 256Mb x16 & 512Mb x8 DDR3: Apr 28, 2024 2) The last shipment date of 25nm 256Mb x16 & 512Mb x8 DDR3: Jul 31,2024 ■ Date Code: onward ■ Lot No: onward ☑ Proposed first ship date: January 31, 2024 Originator: Approval: (QA Approval: (QA) Nuowa Dept. Manager) (QRA Director) Name: Betty Huang TEL:886-3-5678168 (ext.76549) FAX: 886-3-5796124 Address: No. 8, Keya 1st Rd., Daya Dist., Central Taiwan Science Park, Taichung **Contact for Questions** City 42881, Taiwan & Concerns E-mail: Hyhuang8@winbond.com

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Customer Comments:

Note: Please sign this notice, and return to Winbond contact within 30 days. If no response is received within 30 days, this Change Request will be assumed to meet your approval.

Major change: □ Approval	■ Disapproval	□ Conditional Approval :				
Minor change with customer notification: □ Recognition						
Minor change without customer notification: □ Approval □ Disapproval						
□ Conditional Approval :						
Comment:						
Date:						
Dept. name:						
Person in charge:		<u></u>				

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Table 1. The affected part no is listed below.

W634GG6NB11I	W634GG6NB12J	W634GU6NB11J	W634GG8NB-11	W634GU8NB-11
W634GG6NB11J	W634GG6NB-15	W634GU6NB-12	W634GG8NB11I	W634GU8NB11I
W634GG6NB-09	W634GG6NB15I	W634GU6NB12I	W634GG8NB-12	W634GU8NB11J
W634GG6NB09I	W634GU6NB-09	W634GU6NB12J	W634GG8NB12I	W634GU8NB-12
W634GG6NB09J	W634GU6NB09I	W634GU6NB-15	W634GG8NB-15	W634GU8NB12I
W634GG6NB-11	W634GU6NB09J	W634GU6NB15I	W634GG8NB15I	W634GU8NB-15
W634GG6NB-12	W634GU6NB-11	W634GG8NB-09	W634GU8NB-09	W634GU8NB15I
W634GG6NB12I	W634GU6NB11I	W634GG8NB09I	W634GU8NB09I	

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